

Forward-Looking Statements



This document may contain forward-looking statements regarding the business, results of operations, financial condition and earnings outlook of AIXTRON. These statements may be identified by words such as "may", "will", "expect", "anticipate", "contemplate", "intend", "plan", "believe", "continue" and "estimate" and variations of such words or similar expressions. These forward-looking statements are based on the current assessments, expectations and assumptions of the executive board of AIXTRON, of which many are beyond control of AIXTRON, based on information available at the date hereof and subject to risks and uncertainties. You should not place undue reliance on these forward-looking statements. Should these risks or uncertainties materialize or should underlying expectations not occur or assumptions prove incorrect, actual results, performance or achievements of AIXTRON may materially vary from those described explicitly or implicitly in the relevant forward-looking statement. This could result from a variety of factors, such as those discussed by AIXTRON in public reports and statements, including but not limited those reported in the chapter "Risk Report". AIXTRON undertakes no obligation to revise or update any forward-looking statements as a result of new information, future events or otherwise, unless expressly required to do so by law.

Due to rounding, numbers presented throughout this report may not add up precisely to the totals indicated and percentages may not precisely reflect the absolute figures for the same reason.

Our registered trademarks: AIXACT®, AIXTRON®, Close Coupled Showerhead®, EXP®, EPISON®, Gas Foil Rotation®, Optacap™, OVPD®, Planetary Reactor®, PVPD®, STExS®, TriJet®

AIXTRON – 9M/2024 Key highlights





Financials Q3/2024: Robust quarter delivered

- Order Intake with EUR 144m above prior year (Q3/2023: EUR 118m)
- Revenues with EUR 156m at lower half of guided range; delivery of large project shifted to Q4 per customer request
- Gross Profit at EUR 67m; Gross Margin at 43%; improved product mix vs. H1
- EBIT at EUR 38m; EBIT Margin at 24%; improved due to volume and mix effects vs. H1



Progress in SiC and 300mm GaN activities

- <u>SiC</u>: Further uniformity improvements presented at recent ICSCRM now clear leader in performance and cost per wafer
- GaN: Recent market news on 300mm GaN-technology underpin the structural growth expectations in GaN
 - AIXTRON working for many years on a 300mm GaN platform based on leading showerhead technology
 - Several 300mm tools already integrated into R&D and pilot lines of leading semiconductor customers
 - New innovation center fully meeting future 300mm cleanroom requirements to support R&D roadmap



FY/2024 guidance confirmed

Revenues FY/24E: EUR 620m – EUR 660m

• Gross Margin FY/24E: 43% – 45%

• EBIT Margin FY/24E: 22% – 25%



Revenues Q4/24E: EUR 215m – 255m



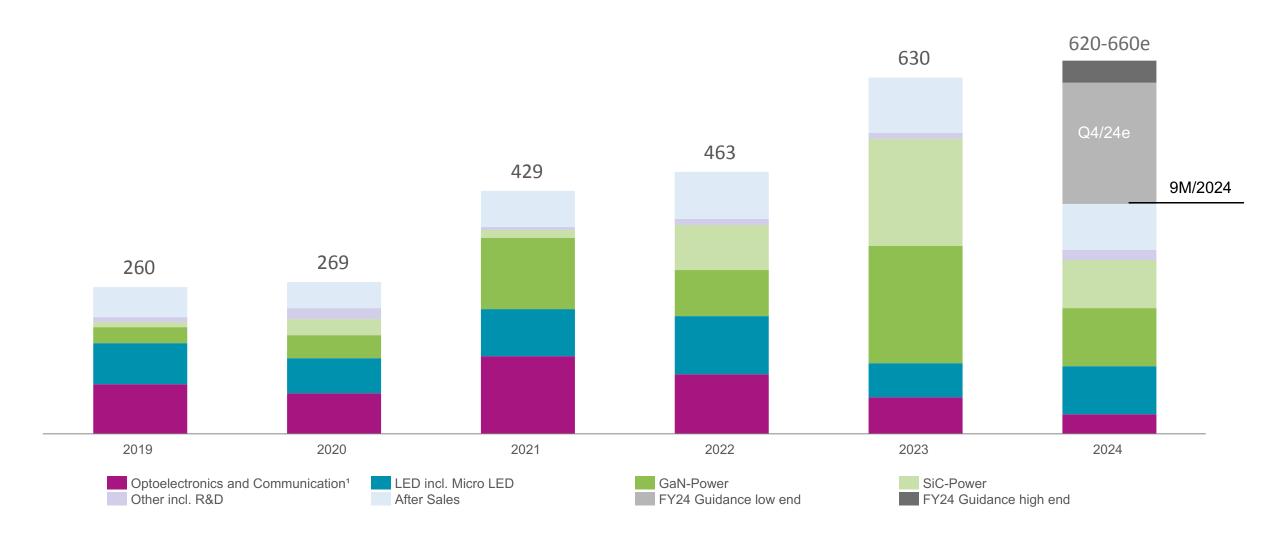
Structural growth drivers fully intact - but visibility on FY/2025 remains low

- Demand in end markets currently weaker than originally expected
- As of today, revenue FY/2025 likely to be on FY/2024 level or slightly below

Annual Revenues by Application - flat to moderate growth in 2024



EUR million



Highlights | Key P&L Indicators



	Revenues	Gross Profit	Margin	EBIT	Margin
Q3	€ 156.3 m -5% YoY	€ 67.1 m -12% YoY	43%	€ 37.5 m -17% YoY	24%
9M	€ 406.4 m -2% YoY	€ 160.0 m -12% YoY	39%	€ 60.3 m -35% YoY	15%



- Gross margin improvement in Q3 vs. H1 due to better mix; further significant step up expected in Q4
- EBIT margin improvement in Q3 vs. H1 due to volume and mix; further significant step up expected in Q4
- R&D costs at peak level due to finalization of G10 family and next gen (300mm) development in parallel

Highlights | Key Balance Sheet & Cash Flow Indicators



	Working Capital ¹	Operating Cash Flow	Free Cash Flow	Cash Balance ²
Q3	€ 385.2 m	€ 15.4 m	€ -1.5 m	€ 78.1 m
	€ +26.8 m vs. Q2/24	€ +10.6 m YoY	€ +0.6 m YoY	€ -1.3 m vs. Q2/24
9M	€ 385.2 m	€ 28.2 m	€ -58.0 m	€ 78.1 m
	€ +31.5 m vs. Q4/23	€ +93.8 m YoY	€ +24.3 m YoY	€ -103.6 m vs. Q4/23



- Inventory burn down kicking in after peak reached in Q2; further positive impact expected in Q4 and throughout 2025
- Working Capital in Q3 increasing due to decrease in payables and customer advance payments
- High Capex in 2024 driven by strategic investments in Innovation Center; significant reduction expected in 2025

¹ Working Capital = Inventories + Trade Receivables - Trade Payables - Contract Liabilities for Advance Payments; excl. FX-effects 2 Including other current financial assets

Renewed product portfolio – strong market adoption of G10 tool family





- 9x150mm (6") or 6x200mm (8")
- Cost benefit of batch tool with uniformity on par with single wafer tool
- Highest productivity in the market
- End Markets/Products:
 Electric vehicles, charging
 infrastructure



- 8x150mm (6") or 5x200mm (8")
- Compact cluster for high volume
 GaN manufacturing
- Designed for replacement of Si power devices with GaN devices
- End Markets/Products:
 GaN Power Electronics & Wireless communication



- 8x150mm (6") or 5x200mm (8")
- Fully automated AsP MOCVD system
- 10x lower defect density than predecessor tool
- End Markets/Products: Micro LED, Optical Communications, 3Dsensing & LiDAR

G10 with significant revenue contribution in 2024

We address a comprehensive set of growth applications with our G10 family of products



Power Electronics



SiC Power

- EV main inverters and EV OBCs
- EV charging infrastructure
- Data centers: AC/DC
- Wind & PV
- Traction & large drives



G10-SiC

G10-AsP





GaN Power & RF

- Fast charging / mobile devices
- Data centers: AC/DC & DC/DC
- Motor drives, e.g., white goods
- Al power delivery
- EV OBCs
- Base stations



Lasers

• Optical data communication

Optoelectronics / LEDs

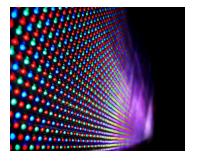
- 3D sensing
- LiDAR
- Industrial power lasers





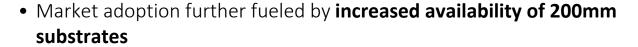
Micro LEDs / Specialty LEDs

- Industrial displays (in/ outdoor)
- TVs
- Smart watches / AR glasses
- Automotive
- Horticulture



G10-SiC - tool of record for low cost SiC Epitaxy & best in class at material uniformity

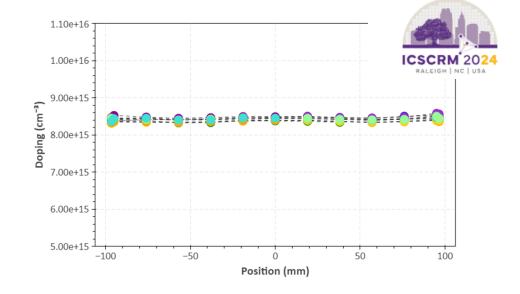




- Multi-ject technology as market disruptor
 - Enables very long epi campaigns without recipe change
 - Now enabling material uniformities
 better than Single Wafer performance reference points



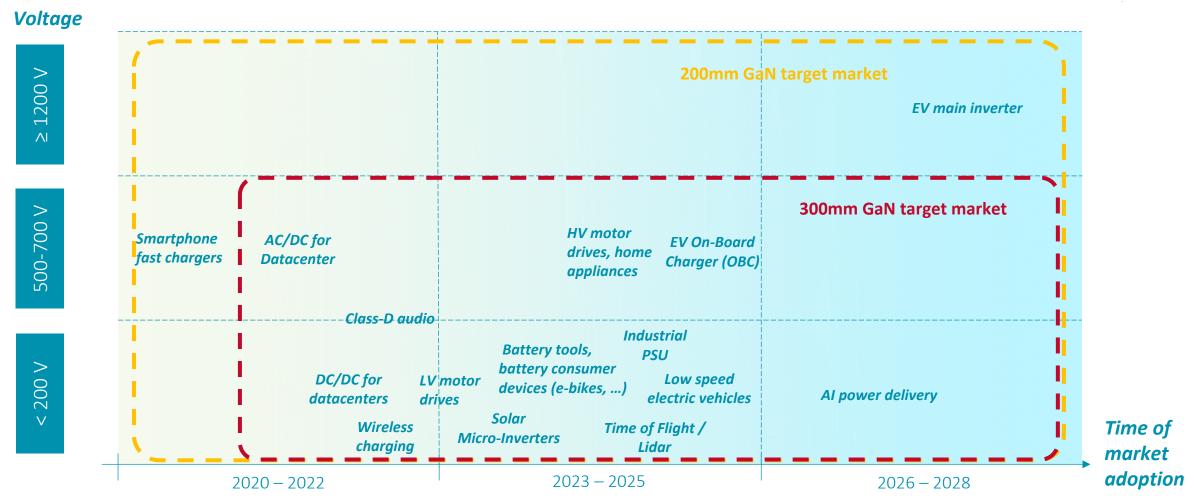




Lab results presented at ICSCRM '24 showing 200mm SiC doping uniformity of (Max-Min)/mean $\pm 0.6 - 0.9\%$

GaN power adoption progressing application by application: co-existence of 200mm and 300mm GaN technology expected

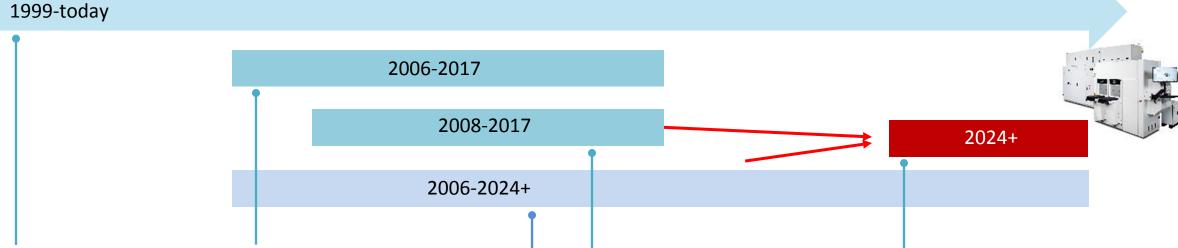




- Co-existence of 200mm and 300mm GaN power expected for extended periods of time
- Reuse strategies for chip-making equipment expected as key driver for 200mm vs. 300mm decisions

In 300mm AIXTRON builds on a long history of showerhead and GaN epi tools





Thomas Swan acquisition

- Showerhead technology
- CCS R&D tools part of AIXTRON portfolio until today





CCS 19x2

Blue LED market (100mm)

- CRIUS-series of GaN epi tools
- >300 units across 4 generations of the equipment



CRIUS II-XL

TFOS^{*)} development (300mm)

- First 300mm showerhead tool developed in collaboration with SEMI customers for CMOS channel
- Effort stopped when market did not materialize



300mm GaN platform

- Building on 30+ years of GaN showerhead experience
- Transfer of success factors developed in 150/200mm GaN
- Enabling ...
 - ... customer re-use of 300mm silicon fab equipment for GaN power applications
 - ... access of GaN technology to most mature lithography nodes at 300mm

Planetary technology (100, 150 & 200mm)

- G4HT / G5HT / G5 / G5+ / G10-GaN series of tools
- >500 units across 5 generations of the equipment
- Core elements of "modern GaN epi" developed

AIXTRON Innovation Center in Herzogenrath (Germany)









- Total invest of EUR ~100 million
- 1,000m² additional cleanroom space
- Allows for collaboration and co-development with customers
- Designed and built for 300mm recent market news on 300mm fully supports decision

First tools moved in as planned in Q3/2024

AIXTRON – Guidance for Q4/2024 and FY/2024



EUR million

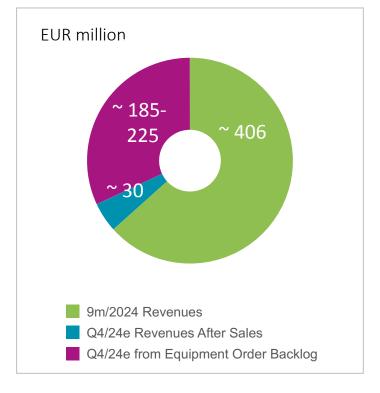
Guidance¹

	37.5	
Revenues	EUR 215m – 255m	EUR 620m – 660m
Gross Margin (%)		43% – 45%
EBIT Margin (%)		22% – 25%

FY/2024¹

Q4/2024¹

Revenue Guidance FY/2024





24 Months Business Development



EUR million



(incl. equipment & after sales)¹

@ \$1.20

160

Q4

2022

140

Q1

@ \$1.15

178

Q2

118

Q3

2023

@ \$1.15

176

Q2

2024

120

Q1

143

Q3

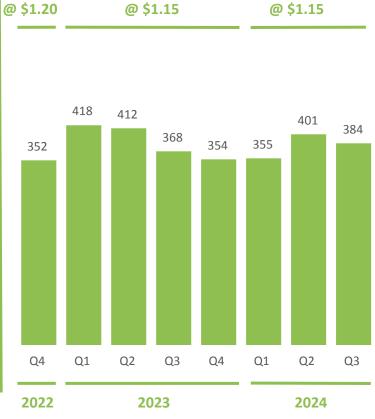
Revenues

(incl. equipment & after sales)²



Order Backlog

(equipment only)¹



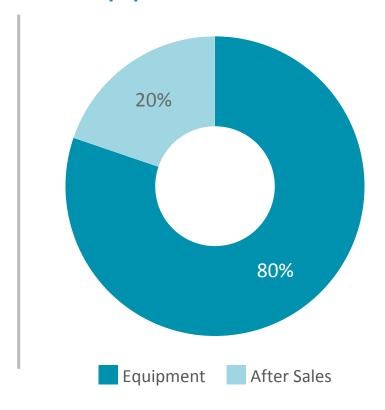
1 USD order intake and backlog were recorded at the prevailing budget rate (2022: \$1.20/€; 2023: \$1.15/€: 2024: \$1.15€) 2 USD revenues were converted at the actual period average FX rate (2022: \$1.06/€; 2023: \$1.08/€; 2024: \$1.09/€)

Q4

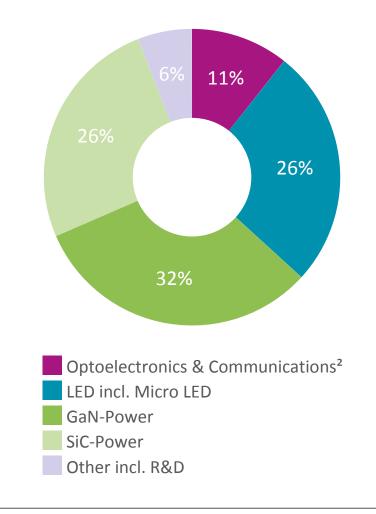
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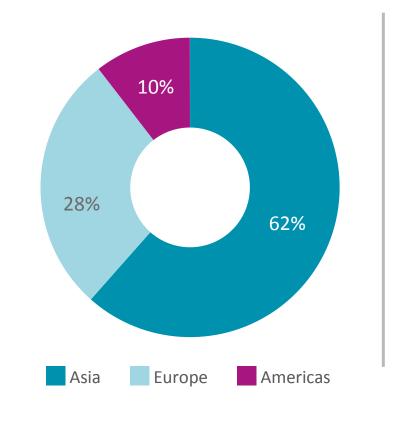
Equipment & After Sales



End Application (equipment only)



Regional Split

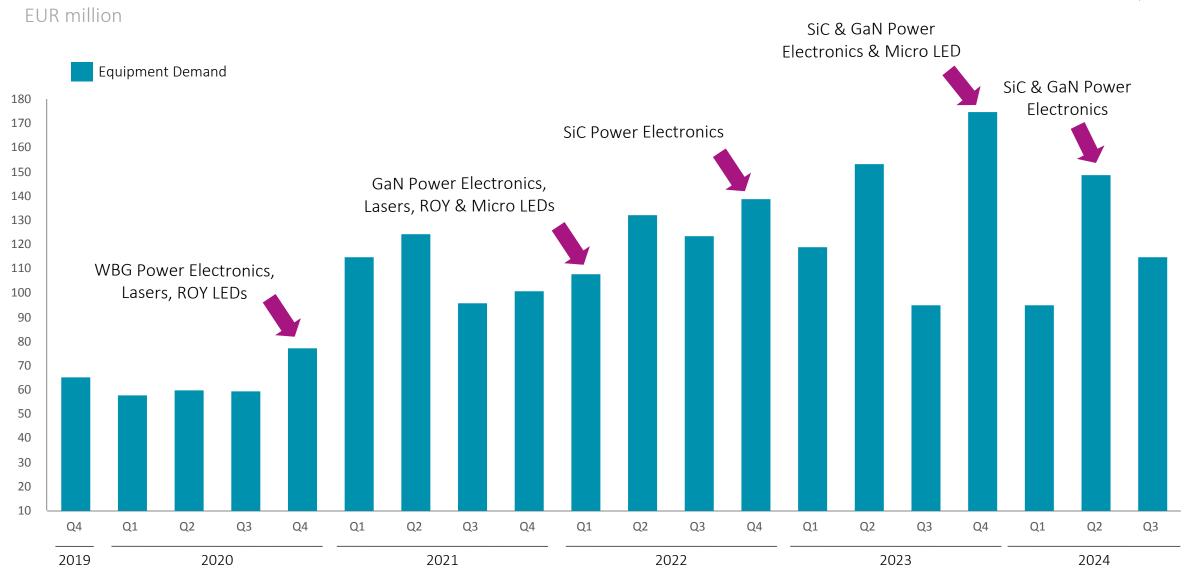


¹ Rounded figures; may not add u

² includes applications in Consumer Optoelectronics, Solar and Telecom/Datacom

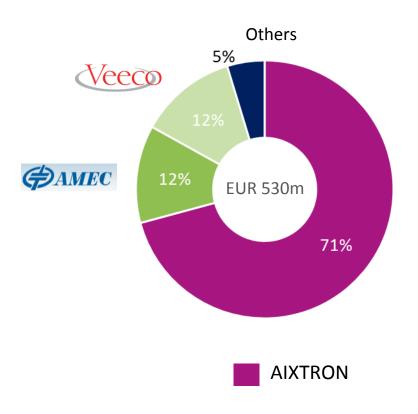
Demand Drivers on Order Intake per Quarter (Equipment Only)



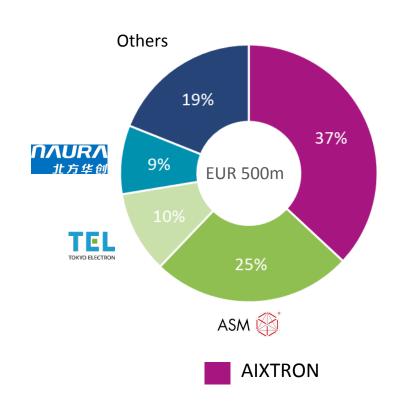




MOCVD (GaN/LED/Opto)



CVD (SiC)



AIXTRON Competitive Landscape – clear market leader



		USA	Europe	China/Taiwan	Korea	Japan
Opto	GaAs/InP Lasers ROY (Micro) LED	Veeco		Hermes Epitek		TAIYO NIPPON SANSO The Gas Professionals
	GaN (Micro) LED	Veeco		TOPEC Hermes Epitek	TE5	TAIYO NIPPON SANSO The Gas Professionals
Power	GaN Power	Veeco		AMEC		TAIYO NIPPON SANSO The Gas Professionals NUFLORE
	SiC Power		ASM 🔯	PASE TECH 版 能		TEL TOKYO ELECTRON

Consolidated Income Statement¹



(EUR million)	9M/2024	9M/2023	+/- (%)	Q3/2024	Q3/2023	+/- (%)
Revenues	406.4	415.7	(2)%	156.3	165.0	(5)%
Cost of sales	246.4	234.9	5%	89.2	88.8	0%
Gross profit	160.0	180.8	(12)%	67.1	76.2	(12)%
Gross margin	39%	43%	<i>(4)pp</i>	43%	46%	(3)pp
Selling expenses	11.0	10.1	9%	3.6	3.4	6%
General & admin expenses	23.9	24.3	(2)%	8.2	7.8	5%
R&D	68.7	59.8	15%	21.2	20.8	2%
Net other operating income	(3.9)	(6.7)	(42)%	(3.5)	(1.1)	218%
EBIT	60.3	93.4	(35)%	37.5	45.3	(17)%
EBIT margin	15%	22%	(7)pp	24%	27%	(3)pp
Net profit	52.9	83.5	(37)%	30.9	39.6	(22)%

Consolidated Balance Sheet¹



(EUR million)	30.09.24	30.06.24	31.12.23
Property, plant & equipment and leased assets	224.3	209.8	147.8
Goodwill	72.6	72.9	72.3
Other intangible assets	5.4	5.4	4.4
Others	42.1	44.5	41.8
Non-current assets	344.5	332.5	266.3
Inventories	426.7	447.9	394.5
Trade receivables	116.4	117.0	157.6
Others	36.6	35.5	30.0
Cash & cash deposits & investments	78.1	79.4	181.7
Current assets	657.7	679.7	763.7
Equity	789.9	758.1	777.6
Non-current liabilities	7.3	7.5	7.7
Trade payables	39.0	72.9	57.8
Contract liabilities for advance payment	118.9	133.0	141.3
Others	47.2	40.7	45.6
Current liabilities	205.1	246.6	244.6
Balance sheet total	1,002.2	1,012.2	1,029.9

Consolidated Statement of Cash Flows¹



(EUR million)	9M/2024	9M/2023	Q3/2024	Q3/2023
Net result	52.9	83.5	30.9	39.6
Adjust for:				
Non-cash items	6.8	4.4	11.3	12.1
Changes in Working Capital ²	(31.5)	(153.5)	(26.8)	(46.9)
Cash flow from operating activities	28.2	(65.6)	15.4	4.9
Capital expenditures/disposals	(86.2)	(16.6)	(17.0)	(7.0)
Free cash flow	(58.0)	(82.3)	(1.5)	(2.2)
FX effects/other	_	(0.5)	0.1	0.9
Cash & cash deposits & investments	78.1	209.9	78.1	209.9

¹ Rounded figures; may not add up

² Working Capital = Inventories + Trade Receivables - Trade Payables - Contract Liabilities for Advance Payments; excl. FX-effects; updated definition applied to all periods

Four Year View on Consolidated Income Statement¹



(EUR million)	FY/23	FY/22	FY/21	FY/20
Revenues	629.9	463.2	429.0	269.2
Cost of sales	350.8	267.9	247.5	161.0
Gross profit	279.0	195.3	181.5	108.3
Gross margin	44%	42%	42%	40%
Selling expenses	14.1	11.2	10.0	9.7
General & admin expenses	32.6	29.2	25.4	18.0
R&D	87.7	57.7	56.8	58.4
Net other operating income	(12.1)	(7.6)	(9.7)	(12.6)
EBIT	156.8	104.7	99.0	34.8
EBIT margin	25%	23%	23%	13%
Net result	145.2	100.5	94.8	34.5

Four Year View on Consolidated Balance Sheet¹



(EUR million)	31.12.2023	31.12.2022	31.12.2021	31.12.2020
Property, plant & equipment and leased assets	147.8	99.0	74.0	63.5
Goodwill	72.3	72.5	72.3	71
Other intangible assets	4.4	3.3	2.2	2.9
Others ²	41.8	34.9	25.4	74.9
Non-current assets	266.3	209.7	174.0	212.2
Inventories	394.5	223.6	120.6	79.1
Trade receivables	157.6	119.7	81.0	41.3
Others	30.0	24.5	12.6	8.1
Cash & cash deposits & investments	181.7	325.2	352.5	249.7
Current Assets	763.7	692.9	566.7	378.2
Equity	777.6	663.3	592.2	496.4
Non-current liabilities	7.7	10.0	8.5	6.6
Trade payables	57.8	46.1	19.6	10.8
Contract liabilities for advance payment	141.3	141.2	77.0	50.8
Others	45.6	41.9	43.4	25.8
Current liabilities	244.6	229.3	140.1	87.5
Balance Sheet total	1,029.9	902.6	740.7	590.4

¹ Rounded figures; may not add up

² Includes cash deposits of €60m as per Dec. 31, 2020

Four Year View on Consolidated Statement of Cash Flows¹



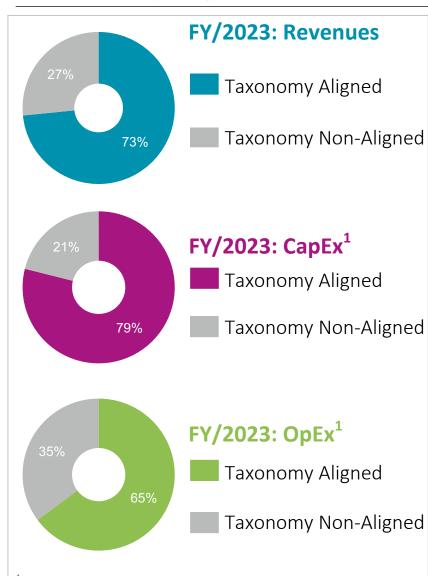
(EUR million)	FY/23	FY/22	FY/21	FY/20
Net Result	145.2	100.5	94.8	34.5
Adjust for:				
Non-Cash Items	4.3	(11.9)	18.3	9.2
Changes in Working Capital ²	(196.8)	(51.5)	(46.7)	(20.4)
Cash Flow from Operating Activities ²	(47.3)	37.1	66.4	23.3
Capital Expenditures/Disposals	(62.4)	(29.5)	(17.4)	(9.3)
Free Cash Flow	(109.7)	7.7	48.7	14.0
FX Effects/Other	(1.7)	(0.4)	3.2	(2.0)
Cash & cash deposits & investments	181.7	325.2	352.5	309.7

¹ Rounded figures; may not add up

² Working Capital = Inventories + Trade Receivables - Trade Payables - Contract Liabilities for Advance Payments; excl. FX-effects; updated definition applied to all periods

EU Taxonomy Alignment & ESG-Ratings – well above industry standard





In line with EU Taxonomy Regulation

EU Taxonomy Aligned Technologies

- Wide Band Gap (WBG) Power
 Semiconductors based on:
 - Gallium Nitride (GaN) and
 - Silicon Carbide (SiC)

Key technologies for energy-efficient Power Electronics

Micro LEDs:

For the next generation of displays

Laser Diodes for Data Communication:

Key technology for the digitalization of our world

Photovoltaics based on Compound Semiconductors:

For high-tech applications (e.g., space applications)

Quantum Technologies:

For neuromorphic computing and quantum sensing

ESG-Ratings

- CDP (Europe):
 - 2023: D (B)
 - 2022: C (B)
- MSCI:
 - 2023: AA
 - 2022: AA
- Sustainalytics:
 - 2023: 19.6 Low risk
 - 2022: 19.2 Low risk
- ISS Oekom:
 - 2023: C-
 - 2022: C-



Our Financial Reporting Dates:

31 Oct. 2024	Q3/24 Results, Conference Call
27 Feb. 2025	FY/24 Results, Conference Call
30 Apr. 2025	Q1/25 Results, Conference Call
31 Jul. 2025	Q2/25 Results, Conference Call
30 Oct. 2025	Q3/25 Results, Conference Call

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Conferences & Roadshows:

05/06 Nov	Roadshow Zurich & Paris
19 Nov	DZ BANK Equity Conference, Frankfurt
20/21 Nov	Morgan Stanley European Technology [et al.]
	Conference 2024, Barcelona
26 Nov	Deutsches Eigenkapitalforum 2024,
	Frankfurt
28/29 Nov	Roadshow Mailand/Lugano
2 Dec	Berenberg European Conference 2024,
	London
9/10 Jan	ODDO BHF Forum 2025, Lyon

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AIXTRON

Our technology. Your future.

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